#### **NICHIA CORPORATION**

### **SPECIFICATIONS FOR WHITE LED**

# NVSW119CT

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



### SPECIFICATIONS

### (1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	$\mathbf{I}_{F}$	1800	mA
Pulse Forward Current	$\mathrm{I}_{FP}$	2400	mA
Allowable Reverse Current	I <sub>R</sub>	85	mA
Power Dissipation	P <sub>D</sub>	5.94	W
Operating Temperature	T <sub>opr</sub>	-40~100	°C
Storage Temperature	T <sub>stg</sub>	-40~100	°C
Junction Temperature	T,	150	°C

\* Absolute Maximum Ratings at  $T_s=25$  °C.

\*  $I_{\mbox{\scriptsize FP}}$  conditions with pulse width  ${\leq}10\mbox{ms}$  and duty cycle  ${\leq}10\%.$ 

#### (2) Initial Electrical/Optical Characteristics

Ite	em	Symbol	Condition	Тур	Max	Unit
			I <sub>F</sub> =700mA	2.98	-	
Forward Voltage		V <sub>F</sub>	I <sub>F</sub> =350mA	2.83	-	V
		<b>•</b>	I <sub>F</sub> =700mA	325	-	
	Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> =350mA	179	-	lm
Rnn	<u>.</u>	÷	I <sub>F</sub> =700mA	93	-	
	Luminous Intensity	Iv	I <sub>F</sub> =350mA	61	-	cd
	Color Rendering Index	Ra	I <sub>F</sub> =700mA	-	-	-
		<b>•</b>	I <sub>F</sub> =700mA	322	-	lm
	Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> =350mA	174	-	
R70	Luminous Intensity	-	I <sub>F</sub> =700mA	92	-	
		$I_v$	I <sub>F</sub> =350mA	60	-	cd
	Color Rendering Index	R <sub>a</sub>	I <sub>F</sub> =700mA	73	-	-
			I <sub>F</sub> =700mA	280	-	
	Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> =350mA	151	-	lm
R8000		-	I <sub>F</sub> =700mA	83	-	
	Luminous Intensity	$I_v$	I <sub>F</sub> =350mA	55	-	cd
	Color Rendering Index	R <sub>a</sub>	I <sub>F</sub> =700mA	83	-	-
	x	-	I <sub>F</sub> =700mA	0.3447	-	-
Chromaticity Coordinate y		-	I <sub>F</sub> =700mA	0.3553	-	-
Thermal Resistance		R <sub>ejs</sub>	-	4.2	6.4	°C/W

\* Characteristics at  $T_s=25$  °C.

\* Luminous Flux value as per CIE 127:2007 standard.

\* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

\*  $R_{\mbox{\tiny HJS}}$  is Thermal Resistance from junction to  $T_{\mbox{\tiny S}}$  measuring point.

### RANKS

Item	Rank		Condition	Min	Max	Unit
	M1		3.1	3.3		
Forward Voltage	L2		$I_F = 700 \text{mA}$	2.9	3.1	V
	L1			2.7	2.9	
	D320			320	340	
	D300			300	320	
Luminous Flux	D280		$I_F = 700 \text{mA}$	280	300	lm
	D260			260	280	
	D240			240	260	
	Rnn	R <sub>a</sub>		-	-	-
	R70 R <sub>a</sub>	1 700 4	70	-	-	
Color Rendering Index	DODOO	Ra	$I_F = 700 \text{mA}$	80	-	-
	R8000	R <sub>9</sub>		0	-	-

#### Color Ranks

The color rank has a chromaticity range within a 3-step MacAdam ellipse.

		Rank	Rank
	sm503	sm573	sm653
х	0.3447	0.3287	0.3123
у	0.3553	0.3417	0.3282
а	0.003555	0.003087	0.002709
b	0.008418	0.007809	0.006561
Φ	-31.78	-31.56	-32.35
	y a b	x         0.3447           y         0.3553           a         0.003555           b         0.008418	sm503         sm573           x         0.3447         0.3287           y         0.3553         0.3417           a         0.003555         0.003087           b         0.008418         0.007809

#### The color rank has a chromaticity range within a 5-step MacAdam ellipse.

		Rank	Rank	Rank
		sm505	sm575	sm655
	х	0.3447	0.3287	0.3123
Center Point	у	0.3553	0.3417	0.3282
Minor Axis	а	0.005925	0.005145	0.004515
Major Axis	b	0.014030	0.013015	0.010935
Ellipse Rotation Angle	Φ	-31.78	-31.56	-32.35

The color rank has a chromaticity range within a 7-step MacAdam ellipse.

		Rank	Rank	Rank
		sm507	sm577	sm657
	х	0.3447	0.3287	0.3123
Center Point	у	0.3553	0.3417	0.3282
Minor Axis	а	0.008295	0.007203	0.006321
Major Axis	b	0.019642	0.018221	0.015309
Ellipse Rotation Angle	Φ	-31.78	-31.56	-32.35

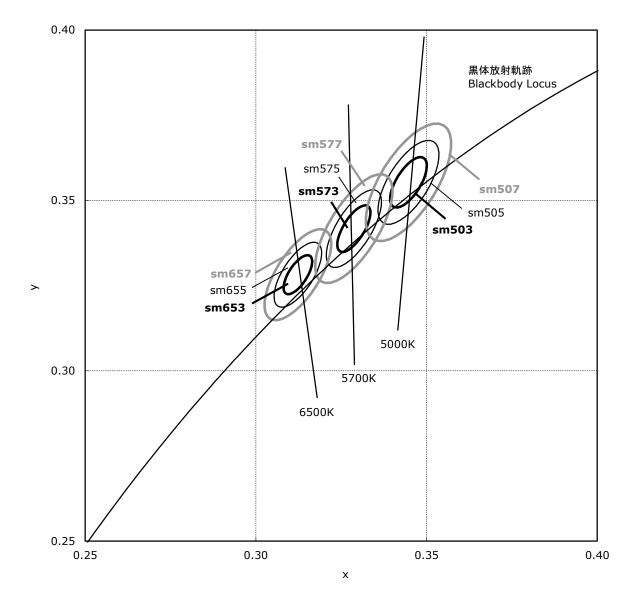
\* Ranking at T<sub>s</sub>=25°C.

- \* Forward Voltage Tolerance: ±0.05V
- \* Luminous Flux Tolerance: ±7%
- \* Color Rendering Index  $R_a$  Tolerance: ±2
- \* Color Rendering Index R<sub>9</sub> Tolerance: ±6.5
- $\ast$  The  $R_9$  value for the above rank shall be greater than 0.
- \* Chromaticity Coordinate Tolerance: ±0.005
- $\ast$  LEDs from the above ranks will be shipped.

The rank combination ratio per shipment will be decided by Nichia.

L	uminous Flux Ranks by Cold	or Rank, Color	Rendering	Index Ra	nk		
	L	Ranking by uminous Flux					
	Ranking by		D240	D260	D280	D300	D320
	Color Coordinates,						
	Color Rendering Index						
		Rnn,R70					
	sm503,sm505,sm507	R8000					
	sm573,sm575,sm577, sm653,sm655,sm657	R70					

# CHROMATICITY DIAGRAM

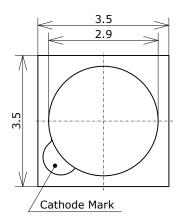


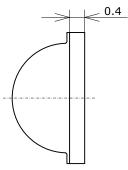
#### 4

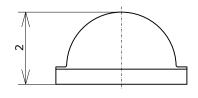
# OUTLINE DIMENSIONS

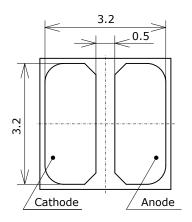
NVSW119C 管理番号 No. STS-DA7-6928

(単位 Unit: mm, 公差 Tolerance: ±0.2)

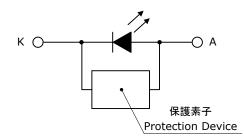








項目 Item	内容 Description
パッケージ材質	セラミックス
Package Materials	Ceramics
封止樹脂材質 Encapsulating Resin Materials	シリコーン樹脂 (蛍光体入り) Silicone Resin (with phosphor)
電極材質	金メッキ
Electrodes Materials	Au-plated
レンズ材質	シリコーン樹脂
Lens Materials	Silicone Resin
質量 Weight	0.030g (TYP)

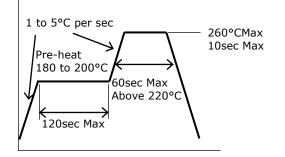


### SOLDERING

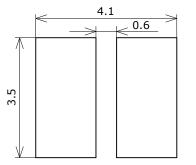
• Recommended Reflow Soldering Condition(Lead-free Solder)

• F	Recommended	Hand	Soldering	Condition

Temperature	350°C Max
Soldering Time	3sec Max



• Recommended Soldering Pad Pattern



(単位 Unit: mm)

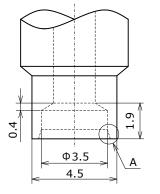
- \* This LED is designed to be reflow soldered on to a PCB. If dip soldered, Nichia cannot guarantee its reliability.
- \* Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.
- \* Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- \* Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- \* Since the silicone used in the encapsulating resin is soft, do not press on the encapsulant resin.
   Pressure can cause nicks, chip-outs, encapsulant delamination and deformation, and bump breaks, decreasing reliability.
   When using automatic pick and place machine, use a pick up nozzle which does not directly apply stress to the encapsulation of the LEDs.

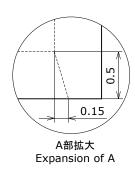
Recommended conditions:

Using a nozzle designed for the LEDs is recommended. (See Figure below)

\* The nozzle must not have any direct contact with the encapsulating resin.

Direct contact with the encapsulating resin may result in internal disconnections causing the LED not to illuminate.





(単位 Unit: mm)

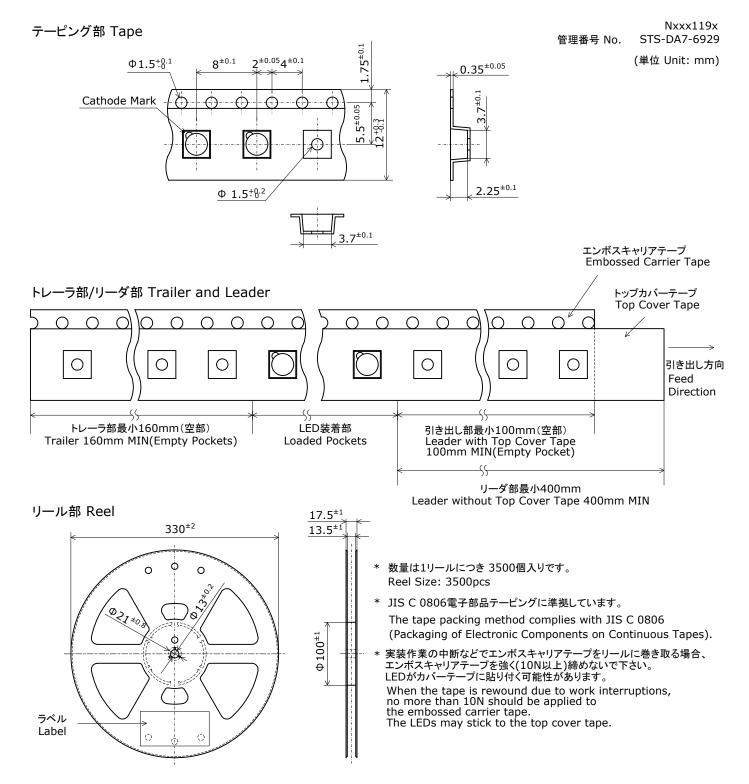
\* Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used.

It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- $\ast$  When soldering, do not apply stress to the LED while the LED is hot.
- \* The recommended soldering pad pattern is designed for attachment of the LED without problems.
   When precise mounting accuracy is required, such as high-density mounting, ensure that the size and shape of the pad are suitable for the circuit design.
- \* Consider factors such as the reflow soldering temperature, hand soldering temperature, etc. when choosing the solder.
- \* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- \* Make sure that there are no issues with the type and amount of solder that is being used.
- \* All of the electrode pads are on the backside of this product; solder connections will not be able to be seen nor confirmed by a normal visual inspection. When using the product, ensure that there are no issues with the soldering conditions.

#### NICHIA STS-DA1-3562B <Cat.No.160129>

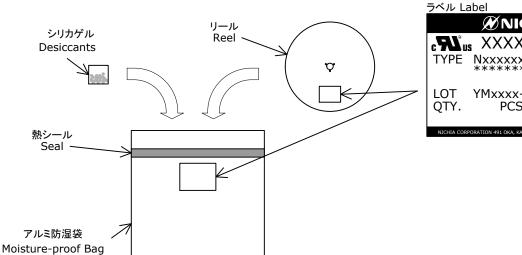
### TAPE AND REEL DIMENSIONS



### PACKAGING - TAPE & REEL

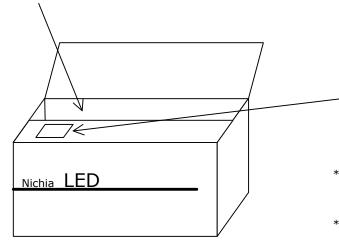
シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。 Reels are shipped with desiccants in heat-sealed moisture-proof bags.

Nxxxxxx STS-DA7-4989 管理番号 No.



**Μ**ΝΙCΗΙΛ CALUS XXXX LED TYPE Nxxxxxx YMxxxx-RRR PCS RoHS

アルミ防湿袋を並べて入れ、ダンボールで仕切ります。 Moisture-proof bags are packed in cardboard boxes with corrugated partitions.





- 客先型名を\*\*\*\*\*\*で示します 客先型名が設定されていない場合は空白です。 \*\*\*\*\*\*\* is the customer part number. If not provided, it will not be indicated on the label.
- ロット表記方法についてはロット番号の項を 参照して下さい。 For details, see "LOT NUMBERING CODE" in this document.
- ランク分けがない場合はランク表記はありません。 The label does not have the RANK field for un-ranked products.
- \* 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。 Products shipped on tape and reel are packed in a moisture-proof bag. They are shipped in cardboard boxes to protect them from external forces during transportation.
- 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。 Using the original package material or equivalent in transit is recommended.

### LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Cui	
Year	Y
2015	F
2016	G
2017	Н
2018	Ι
2019	J
2020	к

#### M - Month

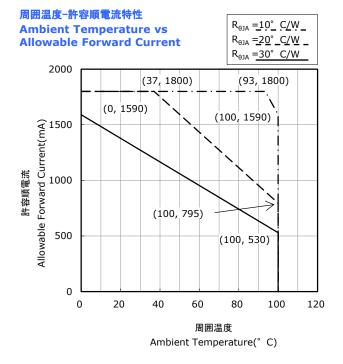
Month	М	Month	М
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	А
5	5	11	В
6	6	12	С

xxxx-Nichia's Product Number

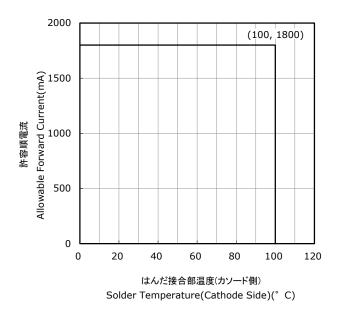
RRR-Ranking by Color Coordinates, Ranking by Luminous Flux, Ranking by Forward Voltage, Ranking by Color Rendering Index

# DERATING CHARACTERISTICS

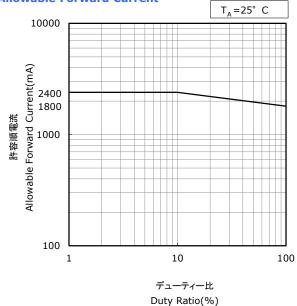
NVSx119C 管理番号 No. STS-DA7-6910



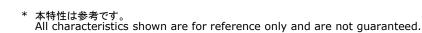
はんだ接合部温度(カソード側)-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current



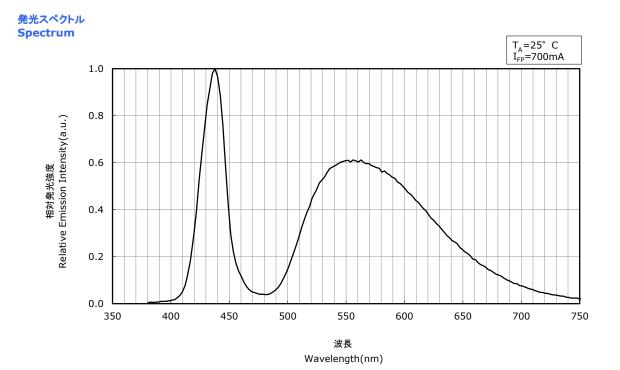
#### デューティー比-許容順電流特性 Duty Ratio vs Allowable Forward Current

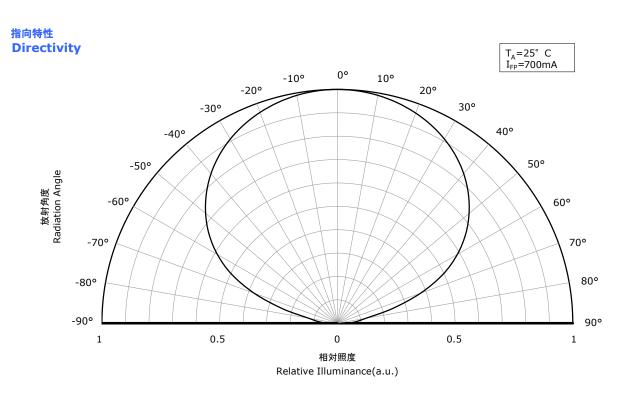


# **OPTICAL CHARACTERISTICS**



NVSW119C 管理番号 No. STS-DA7-6911A

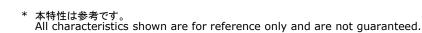




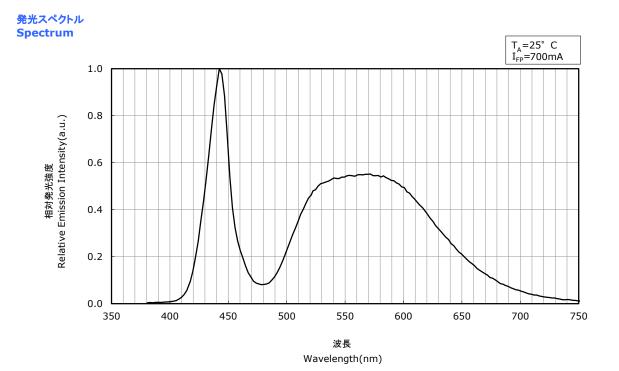
\* 本特性は演色性ランクRnnに対応しています。

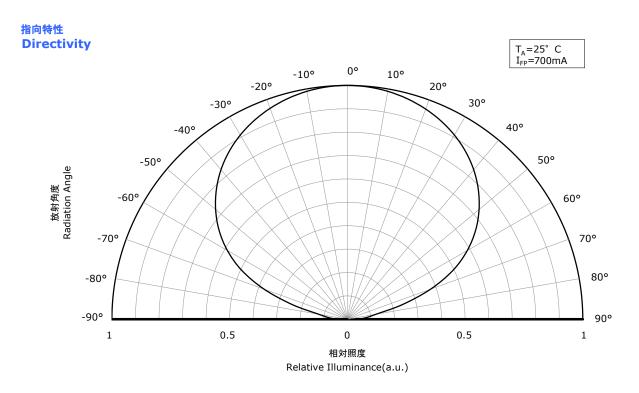
The graphs above show the characteristics for Rnn LEDs of this product.

# **OPTICAL CHARACTERISTICS**



NVSW119C 管理番号 No. STS-DA7-6912A

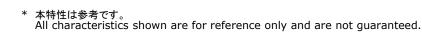




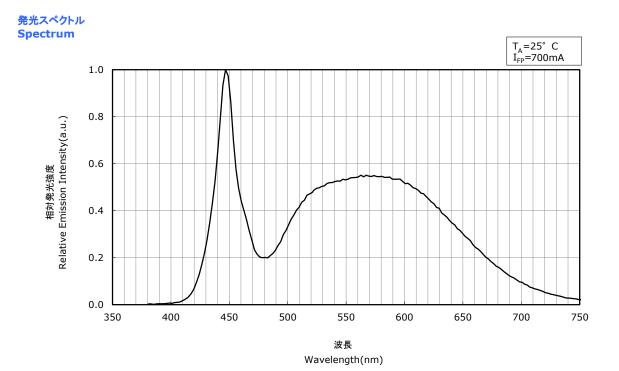
\* 本特性は演色性ランクR70に対応しています。

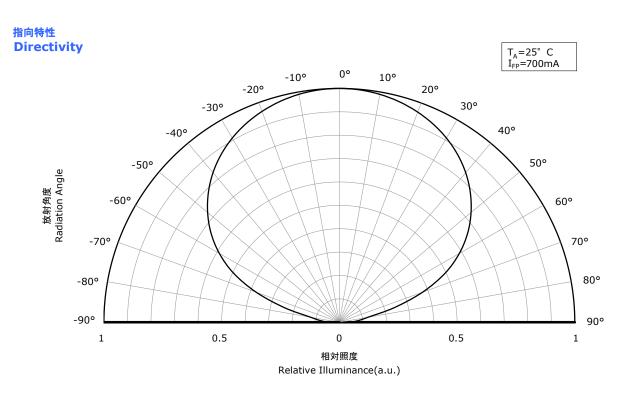
The graphs above show the characteristics for R70 LEDs of this product.

# **OPTICAL CHARACTERISTICS**



NVSW119C 管理番号 No. STS-DA7-6913A





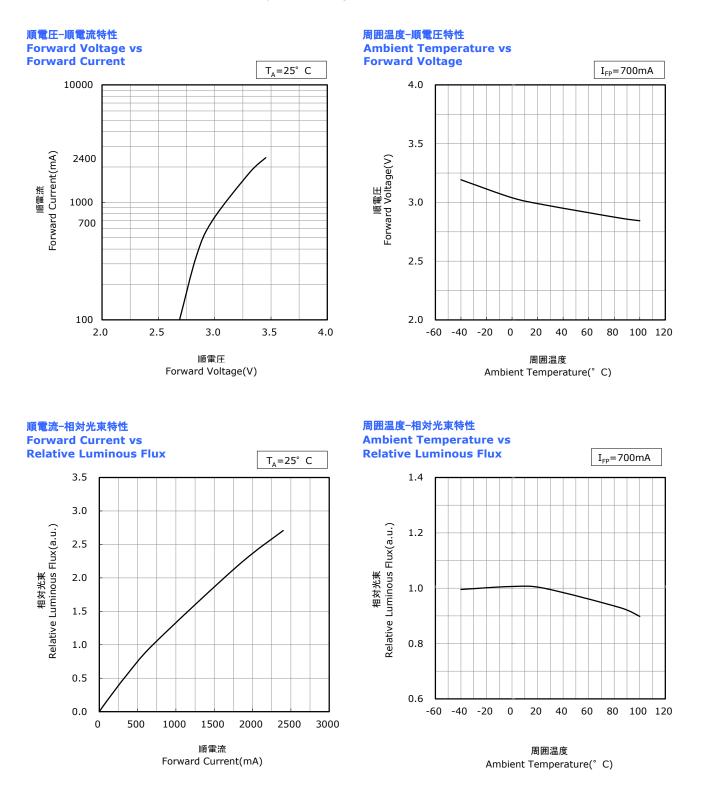
\* 本特性は演色性ランクR8000に対応しています。

The graphs above show the characteristics for R8000 LEDs of this product.

#### \* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

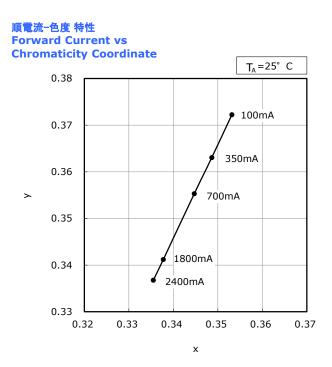
NVSW119C 管理番号 No. STS-DA7-6914A

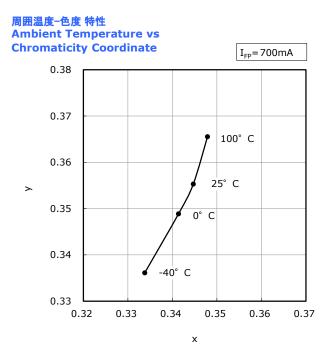


#### \* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

NVSW119C 管理番号 No. STS-DA7-6915A



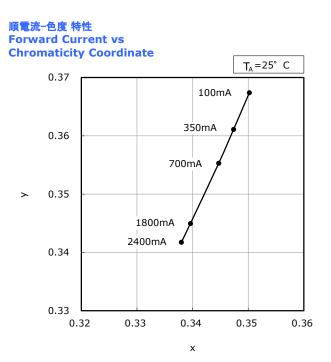


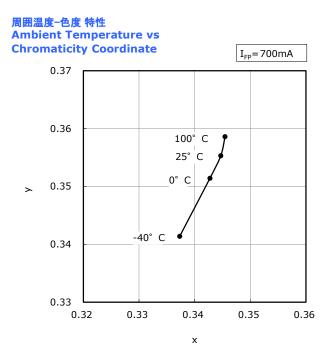
\*本特性は演色性ランクRnnに対応しています。 The graphs above show the characteristics for Rnn LEDs of this product.

#### \* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

NVSW119C 管理番号 No. STS-DA7-6916A



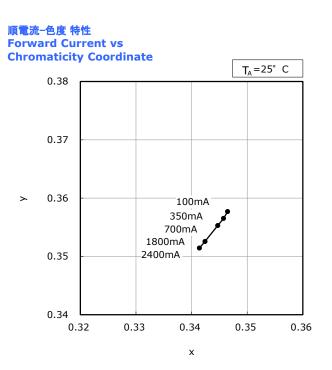


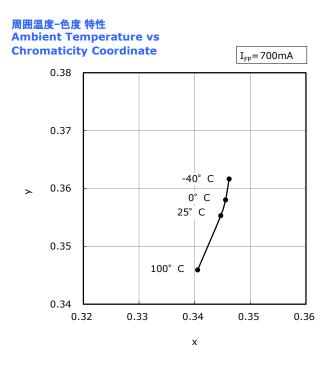
\* 本特性は演色性ランクR70に対応しています。 The graphs above show the characteristics for R70 LEDs of this product.

#### \* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

NVSW119C 管理番号 No. STS-DA7-6917A





\* 本特性は演色性ランクR8000に対応しています。 The graphs above show the characteristics for R8000 LEDs of this product.

# RELIABILITY

### (1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	T <sub>sld</sub> =260°C, 10sec, 2reflows, Precondition: 30°C, 70%RH, 168hr		#1	0/22
Solderability	JEITA ED-4701	T <sub>sld</sub> =245±5°C, 5sec,		#2	0/22
(Reflow Soldering) Temperature Cycle	303 303A JEITA ED-4701 100 105	Lead-free Solder(Sn-3.0Ag-0.5Cu) -40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min) 100cycles		#1	0/22
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	25°C~65°C~-10°C, 90%RH, 24hr per cycle		#1	0/22
High Temperature Storage	JEITA ED-4701 200 201	T <sub>A</sub> =100°C	1000hours	#1	0/22
Temperature Humidity Storage	JEITA ED-4701 100 103	T <sub>A</sub> =60°C, RH=90%	1000hours	#1	0/22
Low Temperature Storage	JEITA ED-4701 200 202	T <sub>A</sub> =-40°C	1000hours	#1	0/22
Room Temperature Operating Life		$T_A=25$ °C, $I_F=1000$ mA Test board: See NOTES below 1000hours		#1	0/22
High Temperature Operating Life		T <sub>A</sub> =100°C, I <sub>F</sub> =400mA Test board: See NOTES below	1000hours	#1	0/22
Temperature Humidity Operating Life		60°C, RH=90%, I <sub>F</sub> =700mA Test board: See NOTES below		#1	0/22
Low Temperature Operating Life		$T_A$ =-40°C, I <sub>F</sub> =700mA Test board: See NOTES below	1000hours	#1	0/22
Vibration	JEITA ED-4701 400 403	200m/s <sup>2</sup> , 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	0m/s <sup>2</sup> , 100~2000~100Hz, 48minutes		0/10
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, 2kV, 1.5kΩ, 100pF, 3pulses, alternately positive or negative		#1	0/22

#### NOTES:

1) Test board: FR4 board thickness=1.6mm, copper layer thickness=0.07mm,  $R_{\text{HJA}} \approx 30^{\circ}$ C/W

2) Measurements are performed after allowing the LEDs to return to room temperature.

#### (2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
	Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =700mA	>Initial value×1.1
#1	Luminous Flux( $\Phi_v$ )	I <sub>F</sub> =700mA	<initial td="" value×0.7<=""></initial>
#2	Solderability	-	Less than 95% solder coverage

# CAUTIONS

### (1) Storage

Conditions		Temperature	Humidity	Time
C.	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤168hours
Baking		65±5°C	-	≥24hours

• Product complies with JEDEC MSL 3 or equivalent. See IPC/JEDEC STD-020 for moisture-sensitivity details.

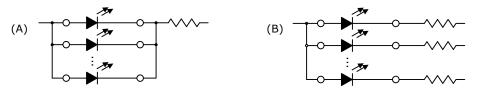
• Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination
and result in optical performance degradation. Products are packed in moisture-proof aluminum bags
to minimize moisture absorption during transportation and storage.
Included cilics and decisions to change from blue to red if mainture had ponetrated have

Included silica gel desiccants change from blue to red if moisture had penetrated bags.

- After opening the moisture-proof aluminum bag, the products should go through the soldering process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- After the "Period After Opening" storage time has been exceeded or silica gel desiccants are no longer blue, the products should be baked. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold, prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish, and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container. Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment where the temperature is higher than normal room temperature.

### (2) Directions for Use

• When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating. Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended. If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.



- This product should be operated using forward current. Ensure that the product is not subjected to either forward or reverse voltage while it is not in use. In particular, subjecting it to continuous reverse voltage may cause migration, which may cause damage to the LED die. When used in displays that are not used for a long time, the main power supply should be switched off for safety.
- It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
- Ensure that excessive voltages such as lightning surges are not applied to the LEDs.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.

#### (3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the bump to break, which will cause the LED not to illuminate.
- When handling the product with tweezers, be careful not to apply excessive force to the resin.

Otherwise, The resin can be cut, chipped, delaminate or deformed, causing bump-bond breaks and catastrophic failures. • Dropping the product may cause damage.

• Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause bump to break, leading to catastrophic failures.

#### (4) Design Consideration

- PCB warpage after mounting the products onto a PCB can cause the package to break. The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines. The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verify the PCB with the products before use. Thermal stress during use can cause the solder joints to crack.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, packing, adhesive, secondary lens, lens cover, etc.) may penetrate the LED lens and/or encapsulating resin.
  If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or cause a color shift.
  In this case, ventilating the environment may improve the reduction in light output and/or color shift.
  Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues, especially if the LEDs are planned to be used in a hermetically sealed environment.

### (5) Electrostatic Discharge (ESD)

- The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.
- When handling the products, the following measures against electrostatic discharge are strongly recommended: Eliminating the charge
  - Grounded wrist strap, ESD footwear, clothes, and floors
  - Grounded workstation equipment and tools
  - ESD table/shelf mat made of conductive materials
- Ensure that tools (e.g. soldering irons), jigs and machines that are being used are properly grounded and that proper grounding techniques are used in work areas. For devices/equipment that mount the LEDs, protection against surge voltages should also be used.
- If tools or equipment contain insulating materials such as glass or plastic, the following measures against electrostatic discharge are strongly recommended: Dissipating static charge with conductive materials
   Preventing charge generation with moisture
  - Neutralizing the charge with ionizers
- The customer is advised to check if the LEDs are damaged by ESD when performing the characteristics inspection of the LEDs in the application.
   Damage can be detected with a forward voltage measurement or a light-up test at low current (≤1mA).
- ESD damaged LEDs may have current flow at a low voltage or no longer illuminate at a low current.

Failure Criteria:  $V_F < 2.0V$  at  $I_F = 0.5 mA$ 

#### (6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T<sub>1</sub>).
- Drive current should be determined for the surrounding ambient temperature  $(T_A)$  to dissipate the heat from the product.
- The following equations can be used to calculate the junction temperature of the products.
  - 1)  $T_J = T_A + R_{\theta JA} \cdot W$  2)  $T_J = T_S + R_{\theta JS} \cdot W$

\*T<sub>J</sub>=LED junction temperature: °C

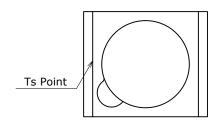
 $T_A$ =Ambient temperature: °C

 $T_s$ =Soldering temperature (cathode side): °C

 $R_{\theta JA}$ =Thermal resistance from junction to ambient: °C/W

 $R_{\mbox{\tiny HJS}}\mbox{=}\mbox{Thermal resistance from junction to }T_{\mbox{\tiny S}}\mbox{ measuring point: }\mbox{°C/W}$ 

W=Input power( $I_F \times V_F$ ): W



### (7) Cleaning

- $\bullet$  The LEDs should not be cleaned with water, benzine, and/or thinner.
- If required, isopropyl alcohol (IPA) should be used. Other solvents may cause premature failure to the LEDs due to the damage to the resin portion. The effects of such solvents should be verified prior to use. In addition, the use of CFCs such as Freon is heavily regulated.
- When dust and/or dirt adheres to the LEDs, soak a cloth with Isopropyl alcohol (IPA), then squeeze it before wiping the LEDs.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs depending on the ultrasonic power and how LED is assembled.
   If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

### (8) Eye Safety

• In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope.

On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope. However, please be advised that some countries and regions have adopted standards based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope. Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1. High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2. Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.

• Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.

### (9) Others

- This product is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the product is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health. This product does not comply with ISO/TS 16949 and is not intended for automotive applications.
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the customer shall inform Nichia directly before disassembling or analysis.
- The specifications and appearance of this product may change without notice; Nichia does not guarantee the contents of this specification. Both the customer and Nichia will agree on the official specifications of supplied products before the volume production of a program begins.